



Vincotech

10-PY126TA075SH-L829F68Y

datasheet

flowPACK 11200 V / 75 A

Features

- High speed IGBT4
- Tandem diodes for improved thermal performance
- Integrated thermal sensor

Target applications

- Embedded Drives
- Industrial Drives

Types

- 10-PY126TA075SH-L829F68Y

flow 1 12mm housing

Schematic

Maximum Ratings

$T_j = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ }^{\circ}\text{C}$	60	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	225	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ }^{\circ}\text{C}$	141	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$ $V_{ce} = 800\text{ V}$ $T_j = 150\text{ }^{\circ}\text{C}$	10	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Diode				
Peak repetitive reverse voltage	V_{RRM}		1300	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	53	A
Repetitive peak forward current	I_{FRM}		150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	107	W
Maximum junction temperature	T_{jmax}		175	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
		AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			min. 12,7	mm
Clearance			7,9	mm
Comparative Tracking Index	CTI		> 200	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0026	25	5,3	5,8	6,3	V
Collector-emitter saturation voltage	V_{CEsat}		15		75	25 125 150	1,78	2,16 2,48 2,56	2,42	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			1	µA
Gate-emitter leakage current	I_{GES}		20	0		25			120	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25		25		4400		pF
Reverse transfer capacitance	C_{res}							235		

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,68		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	± 15	600	75	25 125 150		63 63 63		ns
Rise time	t_r					25 125 150		11 12 13		
Turn-off delay time	$t_{d(off)}$					25 125 150		160 212 224		
Fall time	t_f					25 125 150		32 72 78		
Turn-on energy (per pulse)	E_{on}					25 125 150		1,537 2,356 2,579		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		2,540 4,327 4,844		



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Inverter Diode

Static

Forward voltage	V_F				75	25 125 150		2,78 2,43 2,34	3,84	V
Reverse leakage current	I_R			1300		25			3,8	µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,89		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt = 8280 \text{ A/}\mu\text{s}$ $di/dt = 8041 \text{ A/}\mu\text{s}$ $di/dt = 7429 \text{ A/}\mu\text{s}$	± 15	600	75	25 125 150		83 96 103		A
Reverse recovery time	t_{rr}					25 125 150		73 113 123		ns
Recovered charge	Q_r					25 125 150		2,619 4,803 5,454		µC
Reverse recovered energy	E_{rec}					25 125 150		1,008 1,907 2,174		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		2653 1613 1699		A/µs

Thermistor

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P					25		5		mW
Power dissipation constant						25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$				25		3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1 \%$				25		4000		K
Vincotech NTC Reference									I	



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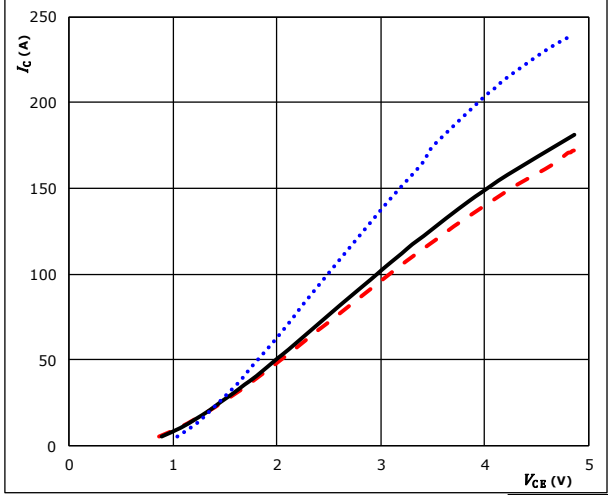
10-PY126TA075SH-L829F68Y datasheet

Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

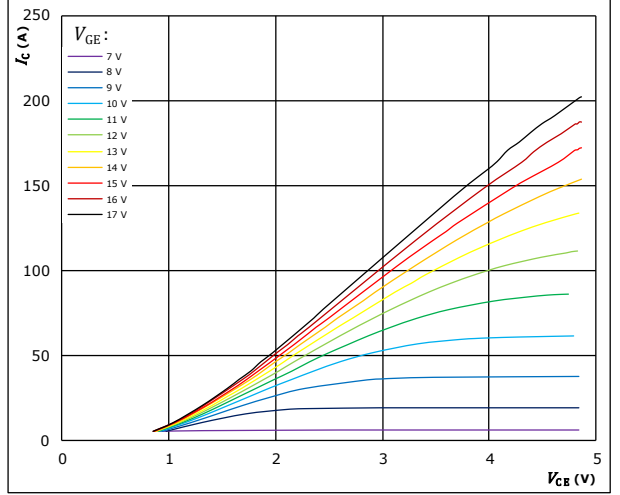


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 \text{ } ^\circ C$ (dotted blue line)
 $125 \text{ } ^\circ C$ (solid black line)
 $150 \text{ } ^\circ C$ (dashed red line)

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

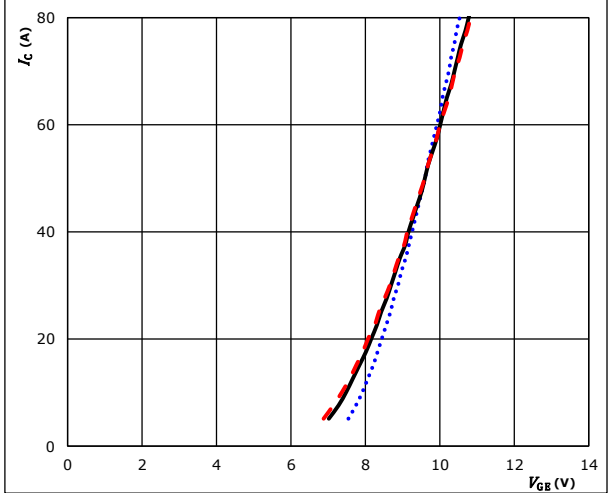


$t_p = 250 \mu s$
 $T_j = 125 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

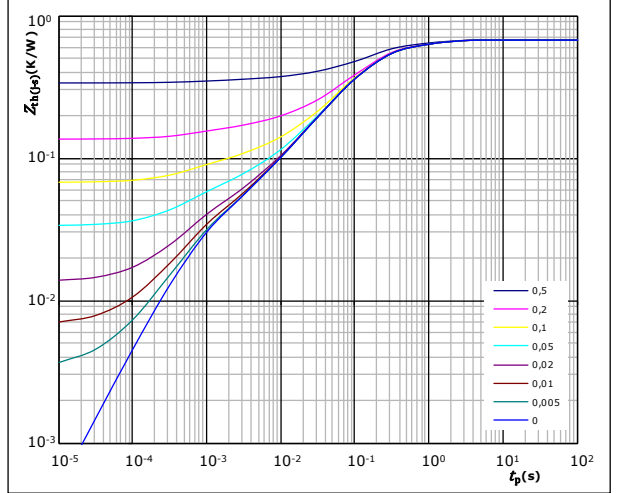


$t_p = 100 \mu s$
 $V_{CE} = 0 V$
 $T_j: 25 \text{ } ^\circ C$ (dotted blue line)
 $125 \text{ } ^\circ C$ (solid black line)
 $150 \text{ } ^\circ C$ (dashed red line)

figure 4. IGBT

Transient thermal impedance as function of pulse duration

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,68 \text{ K/W}$
IGBT thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
1,22E-01	9,38E-01
3,87E-01	1,40E-01
9,92E-02	4,82E-02
3,95E-02	8,51E-03
2,86E-02	7,35E-04



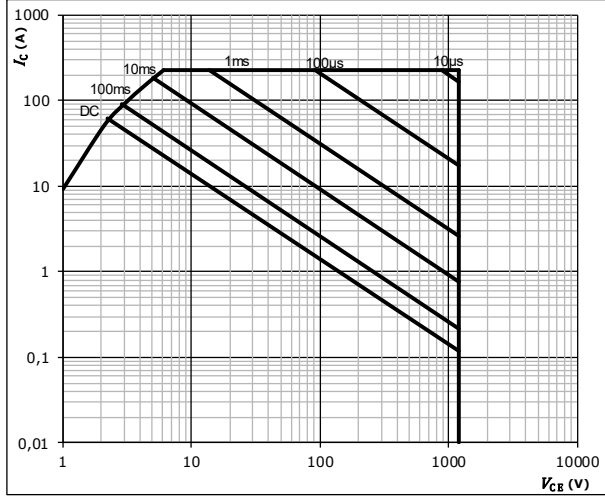
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Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse
 $T_s =$ 80 °C
 $V_{GE} =$ 0 V
 $T_j = T_{jmax}$



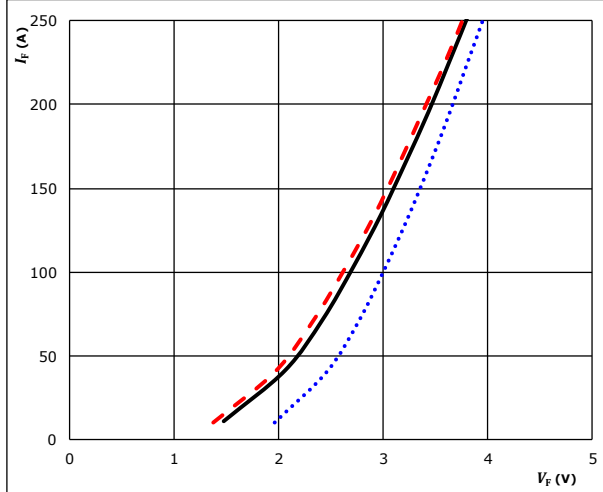
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Inverter Diode Characteristics

figure 1. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

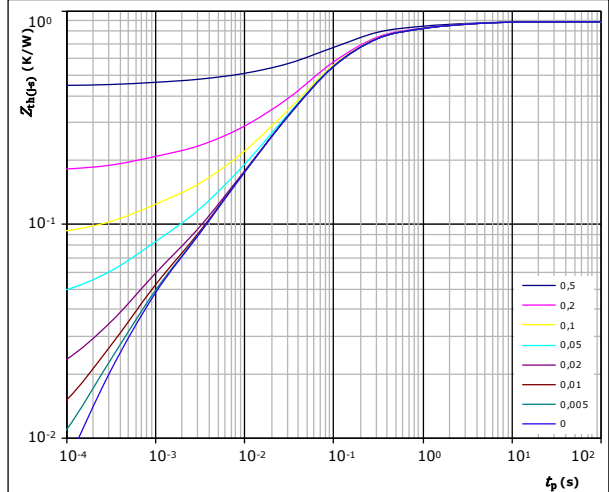


$t_p = 250 \mu s$
 T_j : 25 °C
 125 °C ———
 150 °C - - - -

figure 2. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,89 \text{ K/W}$
 FWD thermal model values

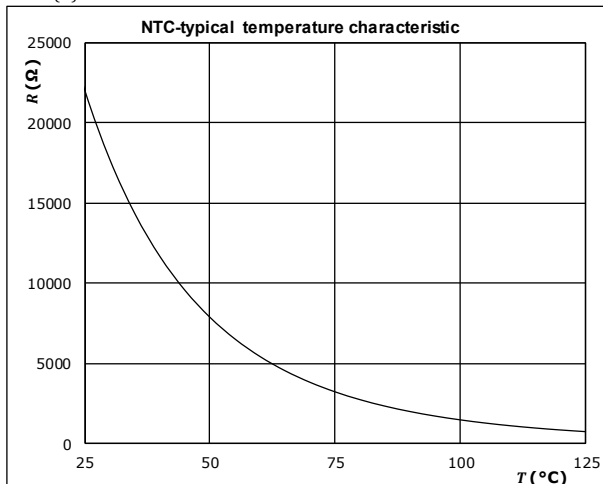
$R \text{ (K/W)}$	$\tau \text{ (s)}$
5,36E-02	3,53E+00
1,18E-01	6,10E-01
4,31E-01	1,15E-01
1,85E-01	3,40E-02
6,73E-02	5,82E-03
3,31E-02	5,88E-04

Thermistor Characteristics

figure 1. Thermistor

Typical NTC characteristic as a function of temperature

$$R = f(T)$$





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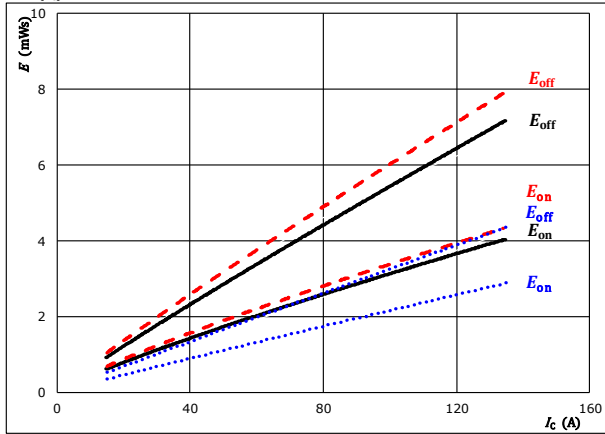
datasheet

Inverter Switching Characteristics

figure 1. IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

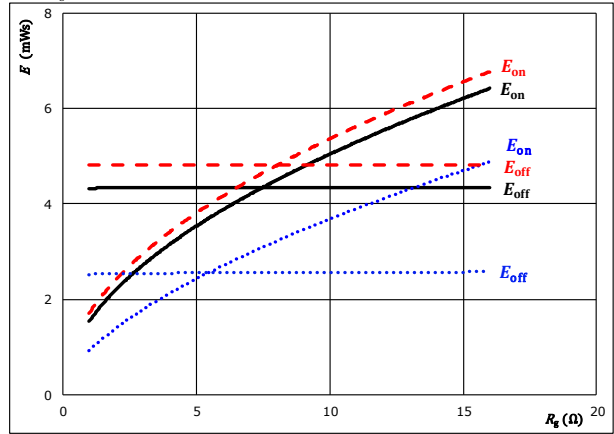
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

T_j : 25 °C (blue dotted)
125 °C (black solid)
150 °C (red dashed)

figure 2. IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

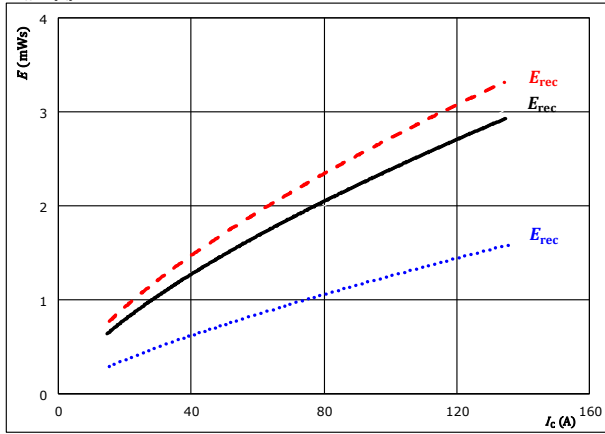
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 75$ A

T_j : 25 °C (blue dotted)
125 °C (black solid)
150 °C (red dashed)

figure 3. FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

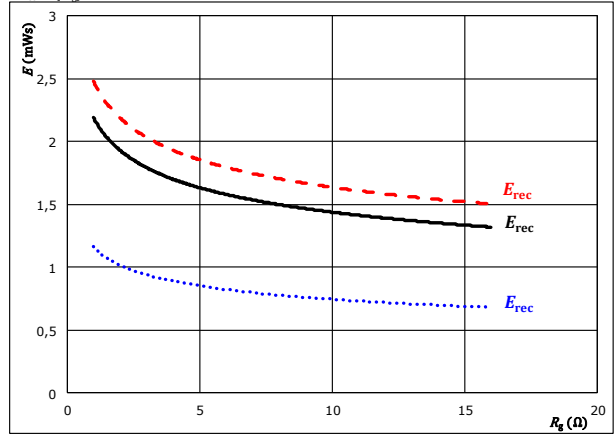
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

T_j : 25 °C (blue dotted)
125 °C (black solid)
150 °C (red dashed)

figure 4. FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 75$ A

T_j : 25 °C (blue dotted)
125 °C (black solid)
150 °C (red dashed)



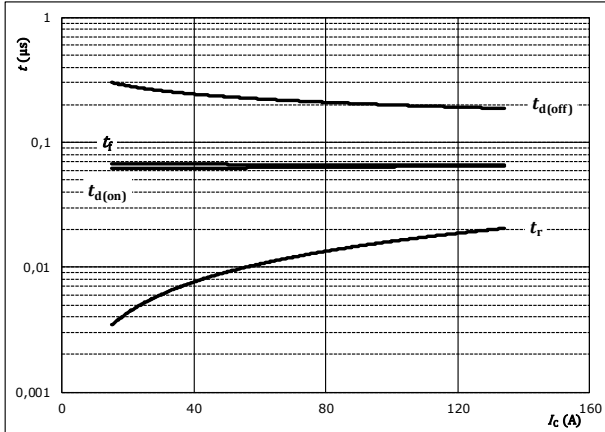
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Inverter Switching Characteristics

figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



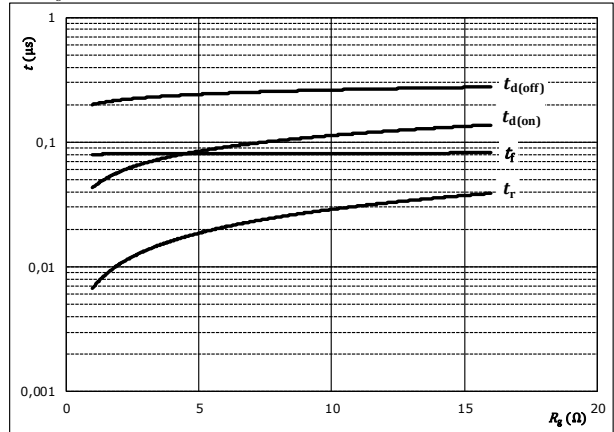
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



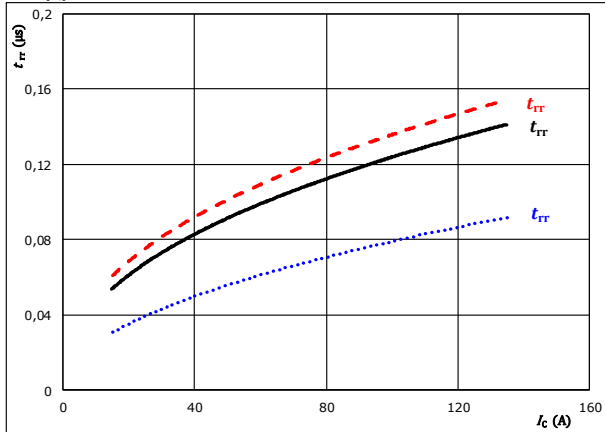
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	75	A

figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



With an inductive load at

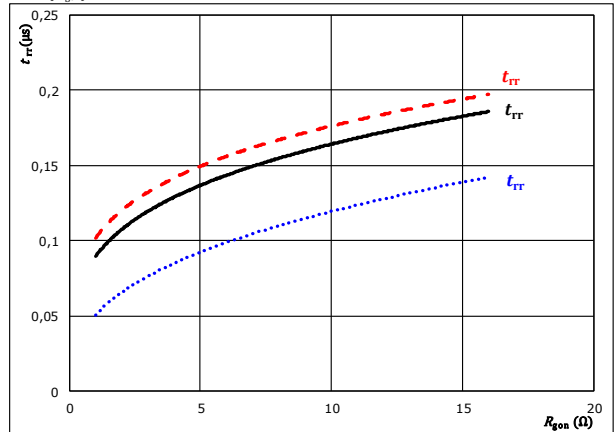
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω

$T_j:$	25 °C	
	125 °C	————
	150 °C	-----

figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



With an inductive load at

$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	75	A

$T_j:$	25 °C	
	125 °C	————
	150 °C	-----



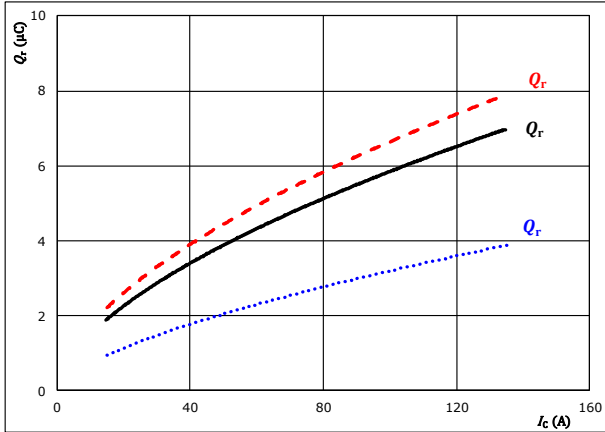
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Inverter Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_C)$$



With an inductive load at

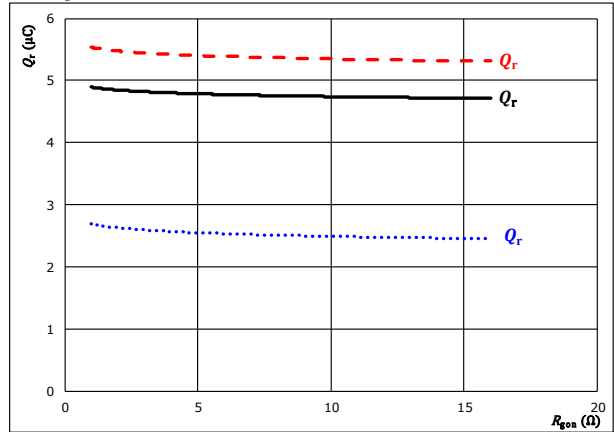
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

T_j : 25 °C (dotted blue)
125 °C (solid black)
150 °C (dashed red)

figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

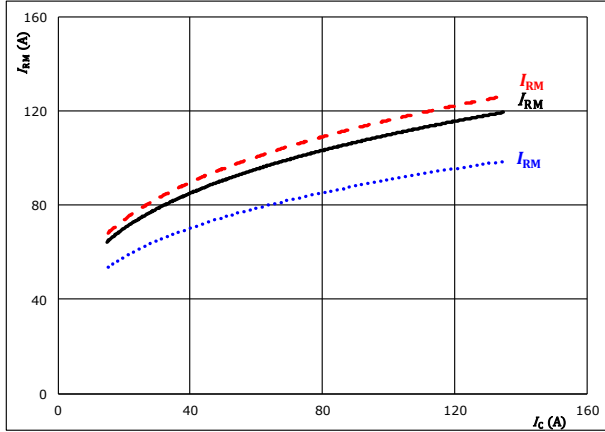
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 75$ A

T_j : 25 °C (dotted blue)
125 °C (solid black)
150 °C (dashed red)

figure 11. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_C)$$



With an inductive load at

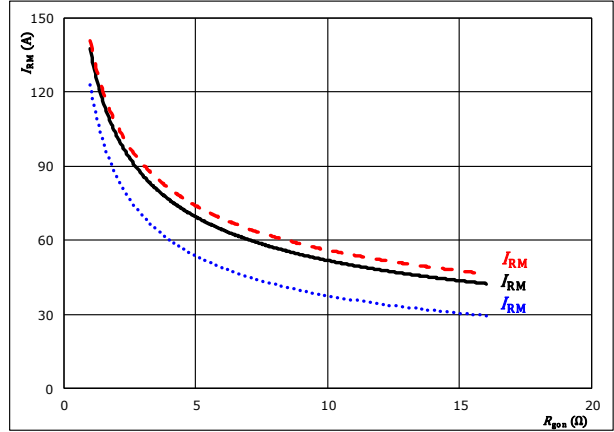
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

T_j : 25 °C (dotted blue)
125 °C (solid black)
150 °C (dashed red)

figure 12. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 75$ A

T_j : 25 °C (dotted blue)
125 °C (solid black)
150 °C (dashed red)

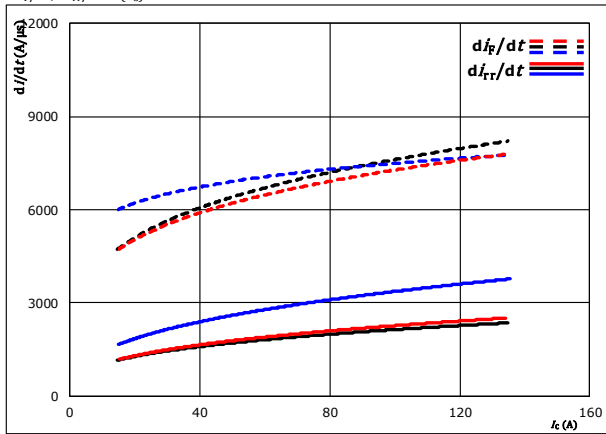


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Inverter Switching Characteristics

figure 13. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_C)$

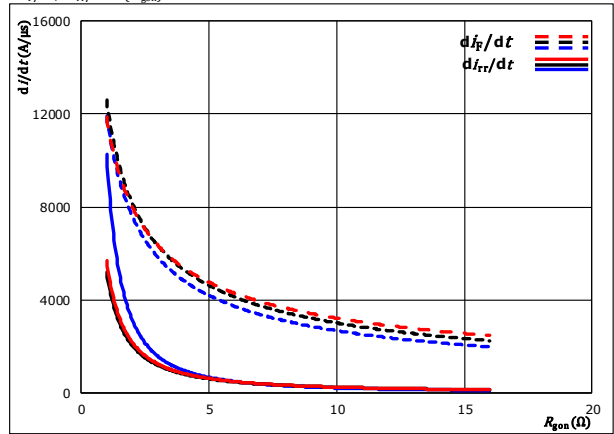


With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 4 \text{ } \Omega$
 $T_j: 25 \text{ } ^\circ\text{C}$
 $125 \text{ } ^\circ\text{C}$
 $150 \text{ } ^\circ\text{C}$

figure 14. FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



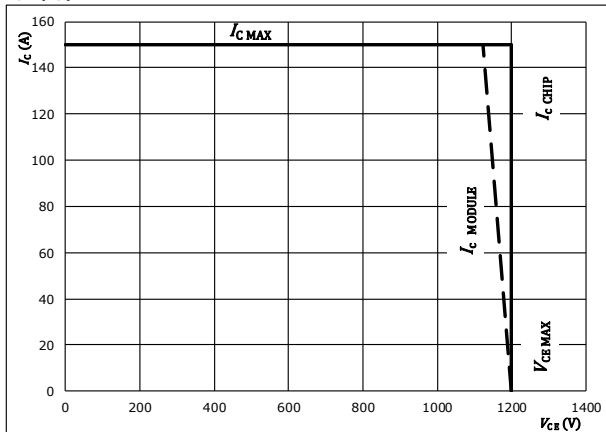
With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 75 \text{ A}$
 $T_j: 25 \text{ } ^\circ\text{C}$
 $125 \text{ } ^\circ\text{C}$
 $150 \text{ } ^\circ\text{C}$

figure 15. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At

$T_j = 125 \text{ } ^\circ\text{C}$
 $R_{gon} = 4 \text{ } \Omega$
 $R_{goff} = 4 \text{ } \Omega$



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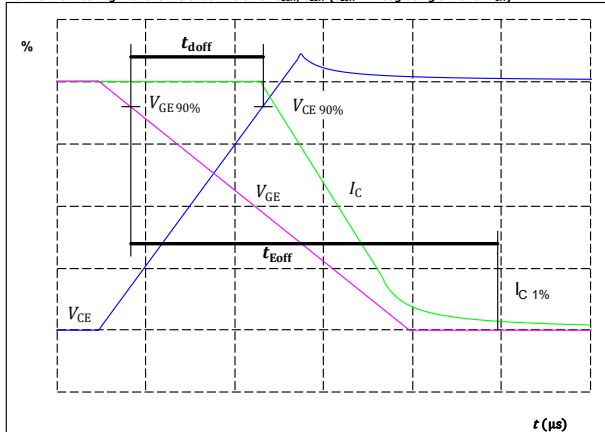
Inverter Switching Definitions

General conditions

T_j	=	125 °C
R_{gon}	=	4 Ω
R_{goff}	=	4 Ω

figure 1. IGBT

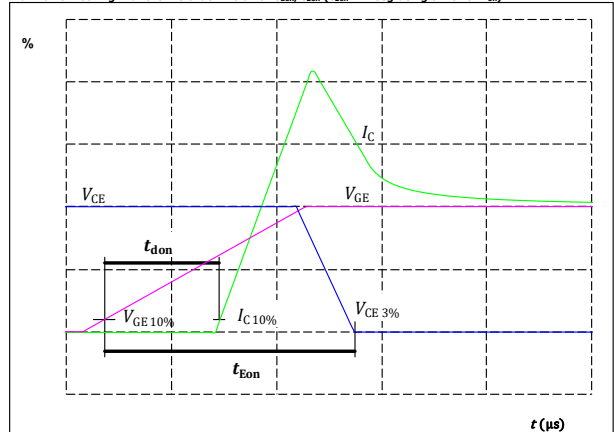
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	75	A
$t_{doff} =$	212	ns

figure 2. IGBT

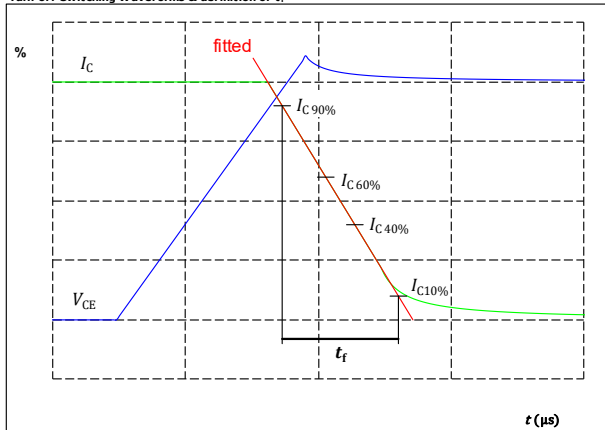
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	75	A
$t_{don} =$	63	ns

figure 3. IGBT

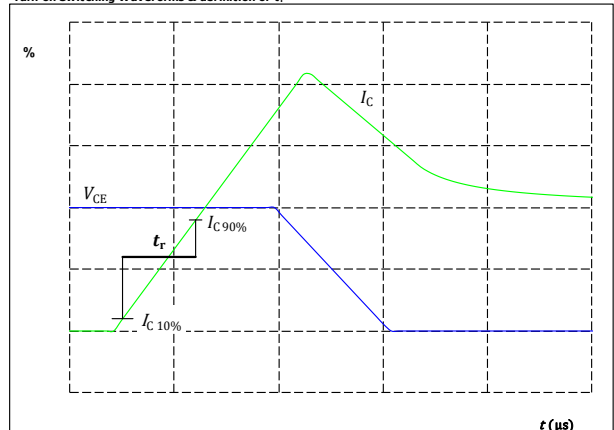
Turn-off Switching Waveforms & definition of t_f



$V_C(100\%) =$	600	V
$I_C(100\%) =$	75	A
$t_f =$	72	ns

figure 4. IGBT

Turn-on Switching Waveforms & definition of t_r



$V_C(100\%) =$	600	V
$I_C(100\%) =$	75	A
$t_r =$	12	ns

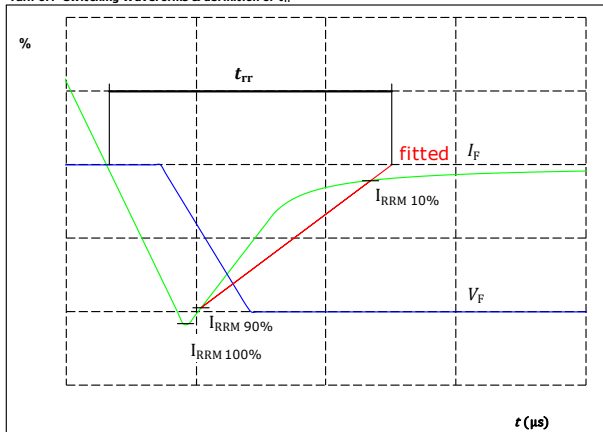


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Inverter Switching Characteristics

figure 5. FWD

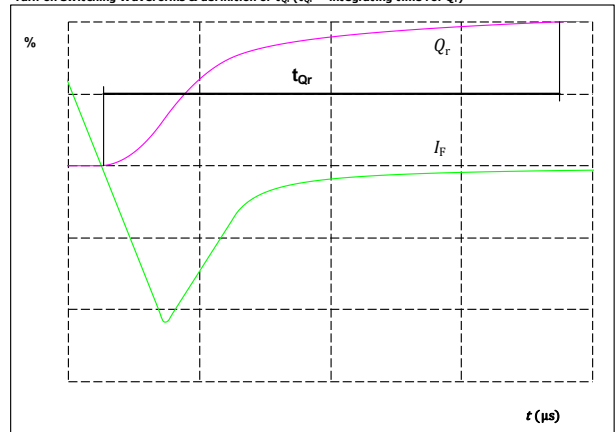
Turn-off Switching Waveforms & definition of t_{rr}



$V_F(100\%) =$	600	V
$I_F(100\%) =$	75	A
$I_{RRM}(100\%) =$	96	A
$t_{rr} =$	113	ns

figure 6. FWD

Turn-on Switching Waveforms & definition of t_{Qr} ($t_{Qr} =$ integrating time for Q_r)



$I_F(100\%) =$	75	A
$Q_r(100\%) =$	4,80	μC

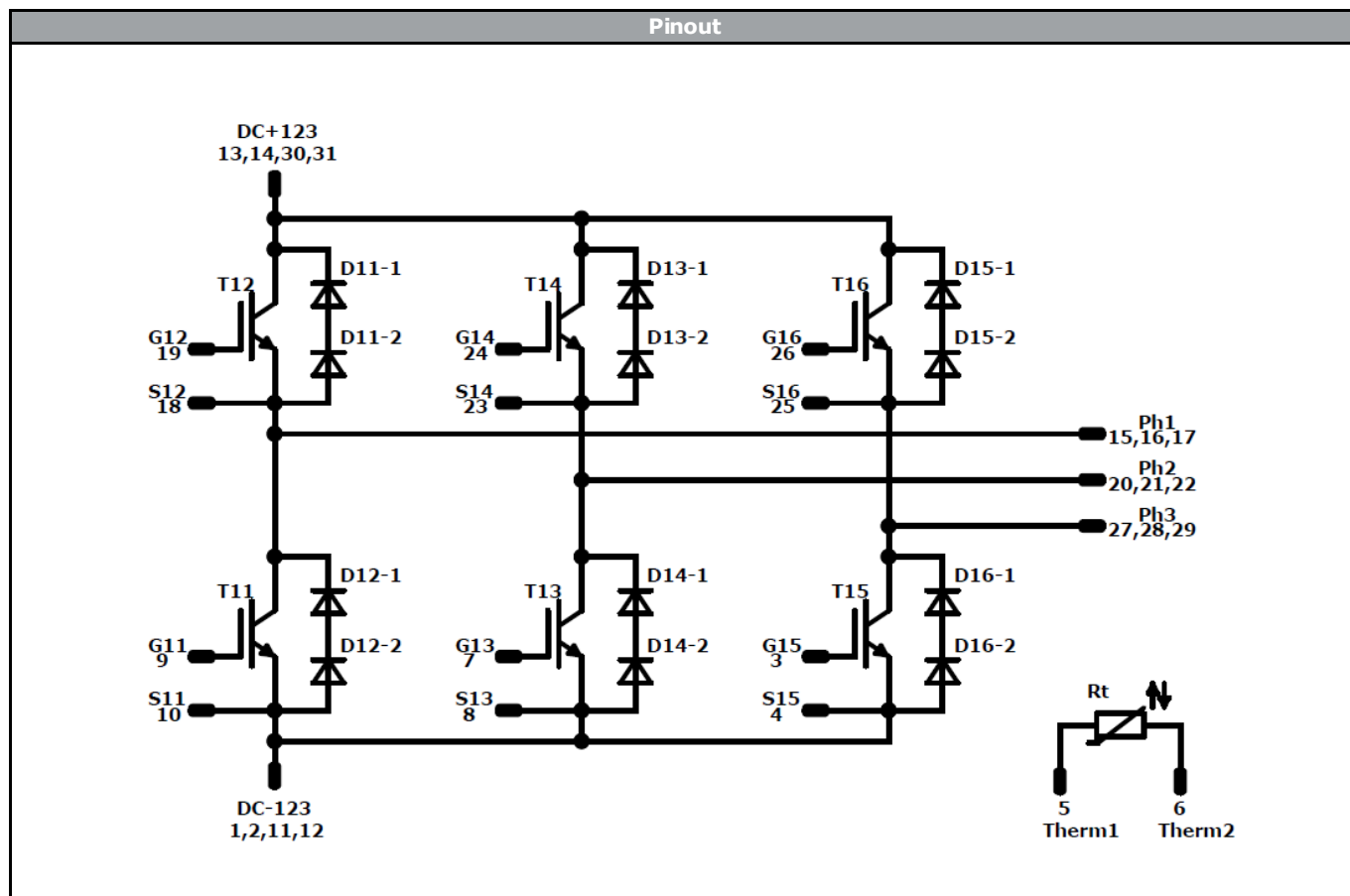


Ordering Code & Marking								
Version				Ordering Code				
without thermal paste 12mm housing with Press-fit pins				10-PY126TA075SH-L829F68Y				
with thermal paste 12mm housing with Press-fit pins				10-PY126TA075SH-L829F68Y-/3/				
		Text	Name		Date code	UL & VIN	Lot	Serial
			NN-NNNNNNNNNNNNNN-TTTTTUV		WWYY	UL VIN	LLLLL	SSSS
		Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTUV	LLLLL	SSSS	WWYY				

Tolerance of pinpositions: $\pm 0,5\text{mm}$ at the end of pins
Dimension of coordinate axis is only offset without tolerance



Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	1200 V	75 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	1300 V	75 A	Inverter Diode	
Rt	NTC			Thermistor	



Vincotech

10-PY126TA075SH-L829F68Y
datasheet

Packaging instruction			
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ Sample

Handling instruction
Handling instructions for <i>flow 1</i> packages see vincotech.com website.

Package data
Package data for <i>flow 1</i> packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-PY126TA075SH-L829F68Y-D1-14	26 Oct. 2018		

DISCLAIMER

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.